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CONFIRMATION NO. 4213

Bib Data Sheet

| SERIAL NUMBER<br>10/511,883 | FILING OR 371(c)<br>DATE<br>10/19/2004<br>RULE | CLASS<br>118 | GROUP ART UNIT<br>1763 | ATTORNEY DOCKET NO.<br>YPL-0108 |
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## APPLICANTS

Young Hoon Park, Kyungki-do, KOREA, REPUBLIC OF;  
Hong Joo Lim, Kyungki-do, KOREA, REPUBLIC OF;  
Sang Kyu Lee, Kyungki-do, KOREA, REPUBLIC OF;  
Hyun Soo Kyung, Kyungki-do, KOREA, REPUBLIC OF;  
Jang Ho Bae, Kyungki-do, KOREA, REPUBLIC OF;

3/23/07

## \*\* CONTINUING DATA \*\*\*\*\*

This application is a 371 of PCT/KR03/00786 04/17/2003

## \*\* FOREIGN APPLICATIONS \*\*\*\*\*

REPUBLIC OF KOREA 10-2002-0021554 04/19/2002

## \*\* SMALL ENTITY \*\*

|   |  |   |                          |                      |                           |
|---|--|---|--------------------------|----------------------|---------------------------|
| Foreign Priority claimed                          | <input checked="" type="checkbox"/> yes <input type="checkbox"/> no  | STATE OR COUNTRY<br>KOREA,<br>REPUBLIC OF | SHEETS<br>DRAWING<br>4 ✓ | TOTAL CLAIMS<br>13 ✓ | INDEPENDENT CLAIMS<br>1 ✓ |
| 35 USC 119 (a-d) conditions met                   | <input checked="" type="checkbox"/> yes <input type="checkbox"/> no <input type="checkbox"/> Met after Allowance |   |                          |                      |                           |
| Verified and Acknowledged<br>Examiner's Signature |  | Initials                                  |                          |                      |                           |

## ADDRESS

23413,

## TITLE

Apparatus and method for depositing thin film on wafer using remote plasma

|                            |   |   |
|----------------------------|---|---|
| FILING FEE RECEIVED<br>555 | FEES: Authority has been given in Paper<br>No. _____ to charge/credit DEPOSIT ACCOUNT<br>No. _____ for following: | <input type="checkbox"/> All Fees<br><input type="checkbox"/> 1.16 Fees ( Filing )<br><input type="checkbox"/> 1.17 Fees ( Processing Ext. of time )<br><input type="checkbox"/> 1.18 Fees ( Issue )<br><input type="checkbox"/> Other _____<br><input type="checkbox"/> Credit |
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